# Series CF Compact Flash Card Reader, Type I and II (w. and w/o Ejector)

# Specifications

Insulation Resistance:  $1000M\Omega$  at 500V DC

Withstanding Voltage: 500Vrms
Current Rating: 0.5A

Operating Temp. Range: -55°C to +85°C

Reflow Solder Temp.: 220°C min. / 60 sec, 260°C peak

Mating Cycles: 10,000 times

### Materials and Finish

Insulator: LCP, glass filled (UL94V-0)

SMT Metal: Brass, pure Sn

Push Button: Glass reinforced PBT (UL94V-0)

Cover: Stainless Steal

Contacts: Brass

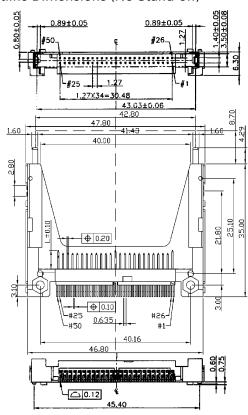
Plating: Contacts - Gold (15µ") over Nickel (40µ")

Solder Tails - pure Sn

#### **Features**

- Adapter for Compact Flash Card Type I and II
- With push button ejector (optional)

### Outline Dimensions (No Stand-off)



# Part Number (Details)

CF 050 P2 - \* 0 3 - \* 0 - DS 2

No. of Contacts

Stand-off Height: 0 = without 1 = 2.20mm

0 = Top Mounted on PCB

 $3 = 90^{\circ} SMT$ 

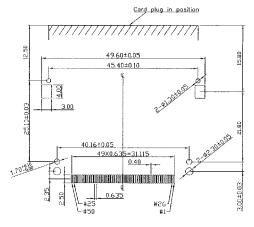
Ejector: 0 = Without 1 = Right Side

Plating Area:

Contacts: Gold (15µ") over 40µ" Nickel Solder Tails: 100µ" Tin over 40µ" Nickel

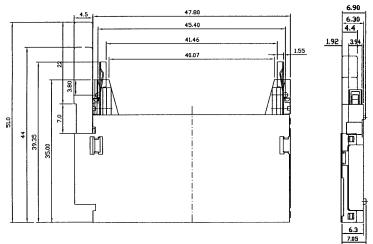
No Mark = Without Cap 2 = With Metal Cap for Automatic Assembly

## Recommended PCB Layout



Interface Dim. L (Length)		
Power	= 5.00mm   Pin#	1, 13, 38, 50
General	= 4.25mm all ot	ner pins
Detect	= 3.50mm   Pin# :	25, 26

# Outline Dimensions (Ejector Option)



# Series CF Compact Flash Card Reader, Type I and II (Reversed Type)





### Specifications

Insulation Resistance:  $1000M\Omega$  at 500V DC

Withstanding Voltage: 500Vrms **Current Rating:** 1A AC/DC max.

**Contact Resistance:** 40mΩ max. at 20mV max.

Operating Temp. Range: -55°C to +85°C

Reflow Solder Temp.: 220°C min. / 60 sec, 260°C peak

Mating Cycles: 10,000 times

### Materials and Finish

LCP, glass filled (UL94V-0) Insulator:

SMT Metal: Brass, pure Sn

Push Button: Glass reinforced PBT (UL94V-0)

Cover: Stainless Steel

Contacts: **Brass** 

Plating: Contacts - Gold (15µ") over Nickel (40µ")

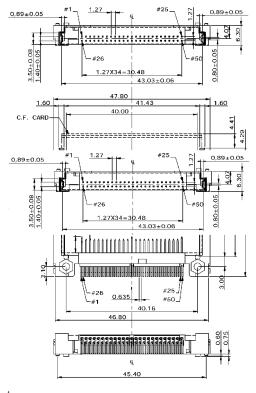
Solder Tails - pure Sn

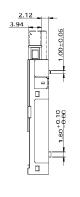
### **Features**

- Adapter for Compact Flash Card type I and II
- Reversed type, for assembly underneath the PCB



### **Outline Dimensions**





# Part Number (Details)

050 P2 - 0 1 3 - \* 0 CF DS 2

Series No. of Contacts Stand-off Height

0 = Without

1 = Bottom Mounted on PCB

 $3 = 90^{\circ} SMT$ 

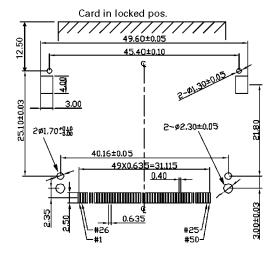
Ejector: 0 = Without 1 = Right Side

Plating Area:

Contacts: Gold (15µ") over 40µ" Nickel Solder Tails: 100µ" Tin over 40µ" Nickel

No Mark = Without Cap 2 = With Metal Cap for Automatic Assembly

# Recommended PCB Layout



Interface Dim. L (Length)

Power 5.00mm | Pin# 1, 13, 38, 50 General 4.25mm all other pins

Detect

3.50mm | Pin# 25, 26

# Outline Dimensions (Ejector Option)

